

October 1995 Revised May 2003

# **NC7S08**

# TinyLogic® HS 2-Input AND Gate

### **General Description**

The NC7S08 is a single 2-Input high performance CMOS AND Gate. Advanced Silicon Gate CMOS fabrication assures high speed and low power circuit operation over a broad  $V_{CC}$  range. ESD protection diodes inherently guard both inputs and output with respect to the  $V_{CC}$  and GND rails. Three stages of gain between inputs and outputs assures high noise immunity and reduced sensitivity to input edge rate.

### **Features**

- Space saving SOT23 or SC70 5-lead package
- Ultra small MicroPak™ leadless package
- High Speed; t<sub>PD</sub> 3.5 ns typ
- $\blacksquare$  Low Quiescent Power; I\_CC < 1  $\mu A$
- Balanced Output Drive; 2 mA I<sub>OL</sub>, -2 mA I<sub>OH</sub>
- Broad V<sub>CC</sub> Operating Range; 2V–6V
- Balanced Propagation Delays
- Specified for 3V operation

# **Ordering Code:**

Order Number	Package Number	Product Code Top Mark	Package Description	Supplied As
NC7S08M5X	MA05B	7S08	5-Lead SOT23, JEDEC MO-178, 1.6mm	3k Units on Tape and Reel
NC7S08P5X	MAA05A	S08	5-Lead SC70, EIAJ SC-88a, 1.25mm Wide	3k Units on Tape and Reel
NC7S08L6X	MAC06A	PP	6-Lead MicroPak, 1.0mm Wide	5k Units on Tape and Reel

# **Logic Symbol**



### **Pin Descriptions**

Pin Names	Description
A, B	Inputs
Y	Output
NC	No Connect

### **Function Table**

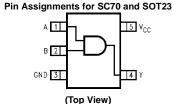
 $\mathbf{Y} = \mathbf{A}\mathbf{B}$ 

Inp	Output			
Α	A B			
L	L	L		
L	Н	L		
Н	L	L		
Н	Н	Н		

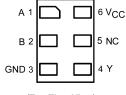
H = HIGH Logic Level

L = LOW Logic Level

## **Connection Diagrams**



### Pad Assignments for MicroPak



(Top Thru View)

 $\label{eq:total_cond} \mbox{TinyLogio} \mbox{$\mathbb{B}$ is a registered trademark of Fairchild Semiconductor Corporation.} \\ \mbox{MicroPak}^{\mbox{$\mathbb{M}$}} \mbox{$\mathbb{M}$ is a trademark of Fairchild Semiconductor Corporation.} \\$ 

### **Absolute Maximum Ratings**(Note 1)

# $\label{eq:supply Voltage VCC} \begin{array}{ll} \text{Supply Voltage (V}_{CC}) & -0.5 \text{V to } +7.0 \text{V} \\ \\ \text{DC Input Diode Current (I}_{IK}) & \\ @\ V_{IN} \leq -0.5 \text{V} & -20 \text{ mA} \\ \\ @\ V_{IN} \geq V_{CC} +0.5 \text{V} & +20 \text{ mA} \\ \end{array}$

 $-0.5\mbox{V}$  to  $\mbox{V}_{\mbox{CC}} + 0.5\mbox{V}$ 

150°C

DC Output Diode Current (I<sub>OK</sub>)

DC Input Voltage (V<sub>IN</sub>)

 $\begin{tabular}{lll} @ V_{OUT} < -0.5V & -20 \ mA \\ \hline @ V_{OUT} > V_{CC} +0.5V & +20 \ mA \\ \hline DC Output Voltage (V_{OUT}) & -0.5V \ to \ V_{CC} +0.5V \\ \hline \end{tabular}$ 

DC Output Source

or Sink Current ( $I_{OUT}$ )  $\pm 12.5 \text{ mA}$ 

DC  $\ensuremath{\text{V}_{\text{CC}}}$  or Ground Current

per Output Pin ( $I_{CC}$  or  $I_{GND}$ )  $\pm 25$  mA Storage Temperature ( $T_{STG}$ )  $-65^{\circ}$ C to  $+150^{\circ}$ C

Junction Temperature (T<sub>J</sub>)

Lead Temperature (T<sub>L</sub>);

(Soldering, 10 seconds) 260°C

Power Dissipation (P<sub>D</sub>) @+85°C

SOT23-5 200 mW SC70-5 150 mW

# Recommended Operating Conditions (Note 2)

Supply Voltage ( $V_{CC}$ ) 2.0V to 6.0V Input Voltage (V<sub>IN</sub>) 0V to V<sub>CC</sub> Output Voltage (V<sub>OUT</sub>) 0V to V<sub>CC</sub> Operating Temperature (T<sub>A</sub>) -40°C to +85°C Input Rise and Fall Time  $(t_r, \, t_f)$ V<sub>CC</sub> @ 2.0V 0 to 1000 ns V<sub>CC</sub> @ 3.0V 0 to 750 ns V<sub>CC</sub> @ 4.5V 0 to 500 ns V<sub>CC</sub> @ 6.0V 0 to 400 ns

Thermal Resistance  $(\theta_{JA})$ 

SOT23-5 300°C/W SC70-5 425°C/W

Note 1: Absolute maximum ratings are those values beyond which damage to the device may occur. The databook specifications should be met, without exception, to ensure that the system design is reliable over its power supply, temperature, and output/input loading variables. Fairchild does not recommend operation of circuits outside databook specifications.

Note 2: Unused inputs must be held HIGH or LOW. They may not float.

### **DC Electrical Characteristics**

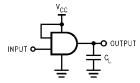
Symbol	Parameter	v <sub>cc</sub>		T <sub>A</sub> = +25°C	;	$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$		Units	Conditions
Symbol		(V)	Min	Тур	Max	Min	Max	Units	Conditions
V <sub>IH</sub>	HIGH Level Input Voltage	2.0	1.50			1.50		V	
		3.0-6.0	0.7 V <sub>CC</sub>			0.7 V <sub>CC</sub>		v	
V <sub>IL</sub>	LOW Level Input Voltage	2.0			0.50		0.50	V	
		3.0-6.0			$0.3\mathrm{V}_{\mathrm{CC}}$		$0.3~\mathrm{V}_{\mathrm{CC}}$	v	
V <sub>OH</sub>	HIGH Level Output Voltage	2.0	1.90	2.0		1.90			
		3.0	2.90	3.0		2.90		V	$I_{OH} = -20 \mu A$ $V_{IN} = V_{IH}$
		4.5	4.40	4.5		4.40		v	$V_{IN} = V_{IH}$
		6.0	5.90	6.0		5.90			
									$V_{IN} = V_{IH}$
		3.0	2.68	2.85		2.63		V	$I_{OH} = -1.3 \text{ mA}$
		4.5	4.18	4.35		4.13		v	$I_{OH} = -2 \text{ mA}$
		6.0	5.68	5.85		5.63			$I_{OH} = -2.6 \text{ mA}$
V <sub>OL</sub>	LOW Level Output Voltage	2.0		0.0	0.10		0.10		
		3.0		0.0	0.10		0.10	V	$I_{OL} = 20 \mu A$ $V_{IN} = V_{IL}$
		4.5		0.0	0.10		0.10	•	$V_{IN} = V_{IL}$
		6.0		0.0	0.10		0.10		
									$V_{IN} = V_{IH}$ or $V_{IL}$
		3.0		0.1	0.26		0.33	V	$I_{OH} = 1.3 \text{ mA}$
		4.5		0.1	0.26		0.33	·	$I_{OL} = 2 \text{ mA}$
		6.0		0.1	0.26		0.33		I <sub>OL</sub> = 2.6 mA
I <sub>IN</sub>	Input Leakage Current	6.0			±0.1		±1.0	μΑ	$V_{IN} = V_{CC}$ , GND
I <sub>CC</sub>	Quiescent Supply Current	6.0			1.0		10.0	μΑ	$V_{IN} = V_{CC}$ , GND

# **AC Electrical Characteristics**

Symbol	Parameter	V <sub>CC</sub>		$T_A = +25^{\circ}C$		$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$		Units	Conditions	Figure
		(V)	Min	Тур	Max	Min I	Max	Omes	Conditions	Number
t <sub>PLH</sub> ,	Propagation Delay	5.0		3.5	15			ns	$C_L = 15  pF$	
t <sub>PHL</sub>		2.0		20	100		125			Figures
		3.0		11	27		35	ns	0 50 - 5	
		4.5		8	20		25	115	$C_L = 50 \text{ pF}$	1, 3
		6.0		7	17		21			
t <sub>TLH</sub> ,	Output Transition Time	5.0		3.0	10			ns	$C_L = 15 pF$	
t <sub>THL</sub>		2.0		25	125		155			l <u>.</u> .
		3.0		16	35		45	ns	C <sub>I</sub> = 50 pF	Figures 1, 3
		4.5		11	25		31		О[ = 50 рі	
		6.0		9	21		26			
C <sub>IN</sub>	Input Capacitance	Open		2	10		10	pF		
C <sub>PD</sub>	Power Dissipation Capacitance	5.0		6				pF	(Note 3)	Figure 2

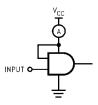
Note 3: C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is derived from dynamic operating current consumption (I<sub>CCD</sub>) at no output loading and operating at 50% duty cycle. (See Figure 2.) C<sub>PD</sub> is related to I<sub>CCD</sub> dynamic operating current by the expression:
I<sub>CCD</sub> = (C<sub>PD</sub>)(V<sub>CC</sub>)(f<sub>IN</sub>) + (I<sub>CC</sub>static).

# **AC Loading and Waveforms**



 $C_L$  includes load and stray capacitance Input PRR = 1.0 MHz;  $t_W$  = 500 ns

FIGURE 1. AC Test Circuit



Input = AC Waveform; PRR = variable; Duty Cycle = 50%

FIGURE 2.  $I_{\rm CCD}$  Test Circuit

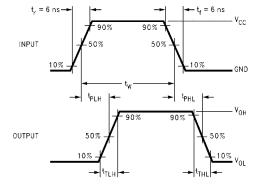


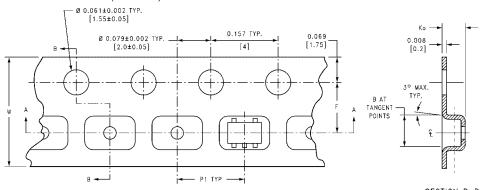
FIGURE 3. AC Waveforms

# **Tape and Reel Specification**

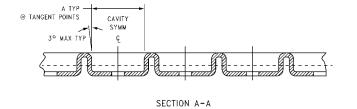
TAPE FORMAT for SC70 and SOT23

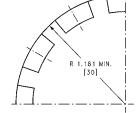
TAPE FORMATION 3	TAFE FORMAT 101 3C/10 and 3C/123								
Package	Таре	Number	Cavity	Cover Tape					
Designator	Section	Cavities	Status	Status					
	Leader (Start End)	125 (typ)	Empty	Sealed					
M5X, P5X	Carrier	3000	Filled	Sealed					
	Trailer (Hub End)	75 (typ)	Empty	Sealed					

### TAPE DIMENSIONS inches (millimeters)



DIRECTION OF FEED \_\_\_\_\_

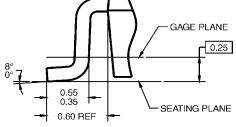




BEND RADIUS NOT TO SCALE

Package	Tape Size	DIM A	DIM B	DIM F	DIM K <sub>o</sub>	DIM P1	DIM W
SC70-5	8 mm	0.093	0.096	$0.138 \pm 0.004$	$0.053 \pm 0.004$	0.157	$0.315 \pm 0.004$
		(2.35)	(2.45)	$(3.5 \pm 0.10)$	$(1.35 \pm 0.10)$	(4)	(8 ± 0.1)
SOT23-5	8 mm	0.130	0.130	$0.138 \pm 0.002$	$0.055 \pm 0.004$	0.157	$0.315 \pm 0.012$
		(3.3)	(3.3)	$(3.5 \pm 0.05)$	$(1.4 \pm 0.11)$	(4)	$(8 \pm 0.3)$

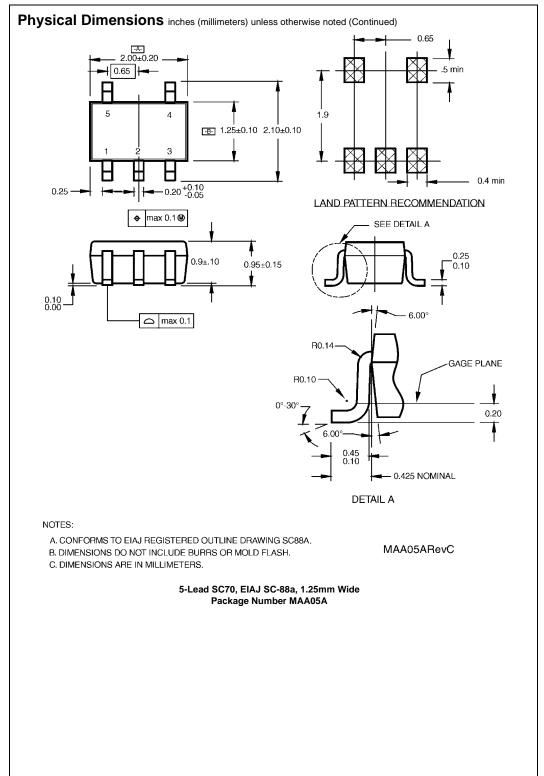
#### Tape and Reel Specification (Continued) TAPE FORMAT for MicroPak Package Tape Number Cavity Cover Tape Designator Section Cavities Status Status Leader (Start End) 125 (typ) Empty Sealed L6X Carrier 5000 Filled Sealed Trailer (Hub End) 75 (typ) **Empty** Sealed 2.00-1.75±0.10 В 8.00 <sup>+0.30</sup> -0.10 3.50±0.05 1.15±0.05 В ∟ø 0.50 ±0.05 SECTION B-B SCALE:10X 0.254±0.020 ┌ 0.70±0.05 SECTION A-A SCALE:10X **REEL DIMENSIONS** inches (millimeters) TAPE SLOT DETAIL X DETAIL X SCALE: 3X W1 W2 W3 Tape В N С D Size 7.0 0.331 + 0.059/-0.000 W1 + 0.078/-0.039 0.059 0.512 0.795 2.165 0.567 8 mm (177.8)(1.50)(13.00)(20.20)(55.00)(8.40 + 1.50 / -0.00)(W1 + 2.00/-1.00)(14.40)



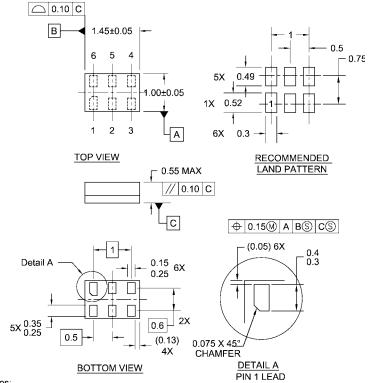
**DETAIL A** 

MA05BRevC

5-Lead SOT23, JEDEC MO-178, 1.6mm Package Number MA05B



### Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



### Notes:

- 1. JEDEC PACKAGE REGISTRATION IS ANTICIPATED 2. DIMENSIONS ARE IN MILLIMETERS
- 3. DRAWING CONFORMS TO ASME Y14.5M-1994

MAC06ARevB

6-Lead MicroPak, 1.0mm Wide Package Number MAC06A

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